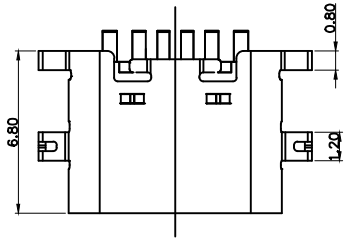
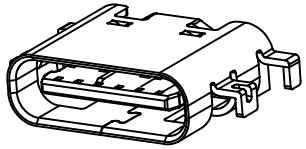
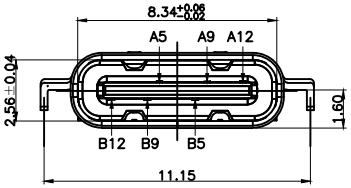
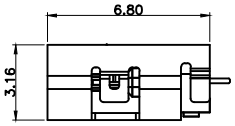
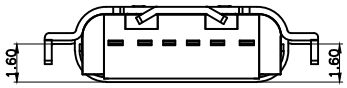
RoHS Compliant

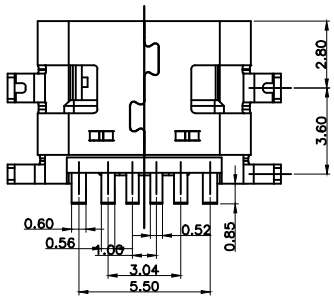


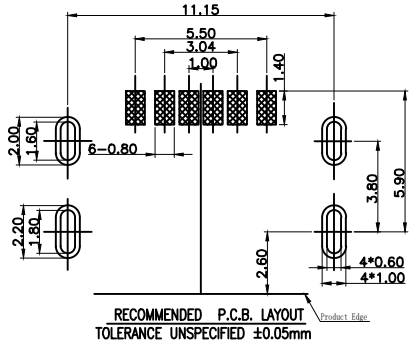


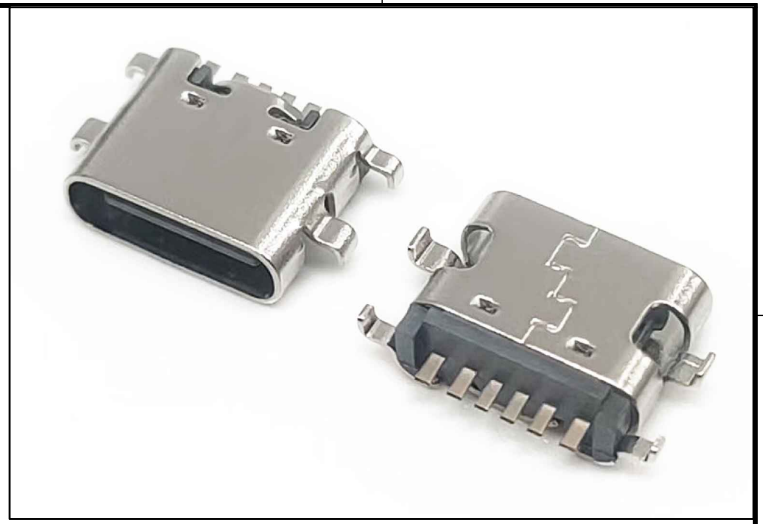












NOTE:

1.MATERIAL SPECIFICATION:
- 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
- 2.CONTACTS:COPPER ALLOY
- 3.MID PLATE: STAINLESS STEEL
- 4.FRONT SHELL: STAINLESS STEEL

2.PLATING SPECIFICATION:
- 2-1.CONTACTS:
  - Ni 50u" MIN. UNDER PLATED OVER ALL.
  - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
  - (GOLD PLATING THICKNESS FOLLOW THE P/N)
  - PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
- 2-2.FRONT SHELL:
  - SEE TABLE1.
- 2-3.SHIELD PLATE&EMI PLATE:
  - CLEAR ONLY

3.MECHANICAL PERFORMANCE,
- 3-1.INSERTION FORCE: 0.5~2.0kgf.
- 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
- 3-3.DURABILITY: 5000 CYCLES.

4.ELECTRICAL PERFORMANCE,
- 4-1. CURRENT RATING:3.0A
  - VOLTAGE RATING:5.0V
- 4-2. LLCR:
  - VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
  - SHIELD: 50mΩ/MAX.
  - LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
- 4-3.INSULATION RESISTANCE: 100MΩ MIN
- 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.

5. ENVIRONMENTAL PERFORMANCE:
   - OPERATING TEMPERATURE: -25°C~+85°C.

6.IR REFLOW:
- THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

PIN ASSIGNMENTS

A5	CC1	B12	GND
A9	VBUS	B9	VBUS
A12	GND	B5	CC2
PIN	SIGNAL NAME	PIN	SIGNAL NAME

SCALE:	UNIT: mm
SIZE: A4	

Unless otherwise General Tolerance:

X.	±0.25
X.x	±0.20
X.xx	±0.15
X.xxx	±0.10
X°	±5°

鸿康科技（东莞）有限公司
Hongkang Technology (Dongguan) Co., Ltd

TITLE:TYPE C母座6PIN 沉板1.6 四脚插板 L=6.8 一模 无弹 PART NO.0041.TCF.6CB.H97

SCALE: 1:1	UNIT: mm	DRAWN	DATE	CHECKED	APPROVED
SHEET: 1/1		LI Xiang	2023.02.31	Gu YiFei	Chen KaiMing